

IN THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1-2 (Cancelled).

Claim 3 (Currently Amended): The synthetic resin molded material according to Claim 2 11, wherein said thin film is a film comprising SiO₂ as the main component.

Claim 4 (Currently Amended): The synthetic resin molded material according to Claim 2 11, wherein said thin film is a thin film comprising oxides of Si and Sn as the main components.

Claim 5 (Currently Amended): The synthetic resin molded material according to Claim 2 11, wherein said thin film is a thin film comprising oxides of Si and Ti as the main components.

Claim 6 (Currently Amended): The synthetic resin molded material according to Claim 2 11, wherein said thin film is a thin film comprising oxides of Si, Sn and Ti as the main components.

Claims 7-8 (Cancelled).

Claim 9 (Currently Amended): The synthetic resin molded material according to ~~any one of Claims 1 to 6~~ Claim 11, wherein said synthetic resin molded material is a covering material for an agricultural or horticultural house.

Claim 10 (Cancelled).

Claim 11 (New): A synthetic resin molded material comprising a thin film made of a mixture of Si oxide and an oxide of at least one metal selected from the group consisting of Zr, Ti, Ta, Nb, Sn, and Zn, formed by a sputtering method on a synthetic resin substrate having hydrophobicity,

wherein said thin film has a thickness of up to 100 nm;

wherein said synthetic resin substrate is a tetrafluoroethylene type resin; and

wherein the Si content is from 50 to 80 atomic % of the total metals.

Claim 12 (New): A method for producing a synthetic resin molded material comprising a thin film made of a mixture of Si oxide and an oxide of at least one metal selected from the group consisting of Zr, Ti, Ta, Nb, Sn and Zn, wherein said film is formed by a sputtering method on a tetrafluoroethylene type resin substrate having hydrophobicity, wherein said thin film has a thickness of up to 100 nm.

Claim 13 (New): The synthetic resin molded material according to Claim 11, wherein said tetrafluoroethylene type resin is a tetrafluoroethylene/ethylene copolymer.

Claim 14 (New): The method according to Claim 12, wherein said tetrafluoroethylene type resin substrate is a tetrafluoroethylene/ethylene copolymer substrate.

DISCUSSION OF THE AMENDMENT

Claims 1 and 2 have been cancelled and replaced with new Claim 11, which is supported by the cancelled claims, combined with the disclosure in the specification at the paragraph bridging pages 4 and 5; page 6, lines 16-17; and page 10, lines 4-6. Each of Claims 3-6 and 9 have been amended to depend on Claim 11. Claims 7 and 8 have been cancelled. Claim 10 has been cancelled and replaced with new Claim 12, which is supported by the cancelled claim and corresponds in scope with new Claim 11. New Claims 13 and 14 are supported in the specification at page 10, lines 14 and 16-21.

No new matter has been added by the above amendment. Claims 3-6, 9, and 11-14 are now pending in the application.